

Electronic Patent Application Fee Transmittal

Application Number:	10519152
Filing Date:	10-Aug-2005
Title of Invention:	Porous substrate and its manufacturing method, and gan semiconductor multilayer substrate and its manufacturing method
First Named Inventor/Applicant Name:	Masatomo Shibata
Filer:	Paul J. Esatto/Vivian Henriquez
Attorney Docket Number:	23165

Filed as Large Entity

U.S. National Stage under 35 USC 371 Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
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Basic Filing:

Pages:

Claims:

Miscellaneous-Filing:

Petition:

Petition-revive unintent. abandoned appl	1453	1	1620	1620
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Patent-Appeals-and-Interference:

Post-Allowance-and-Post-Issuance:

Extension-of-Time:

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				1620